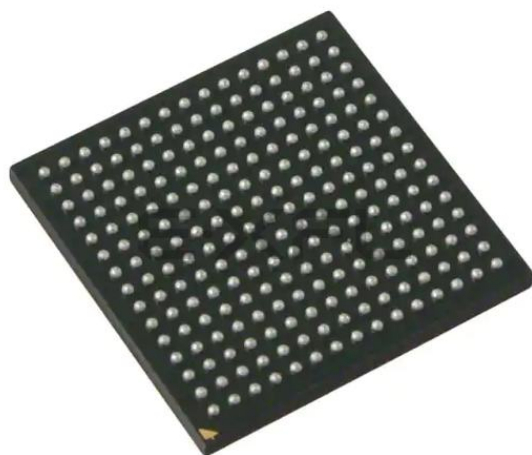




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The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	1139
Number of Logic Elements/Cells	14579
Total RAM Bits	589824
Number of I/O	160
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	225-LFBGA, CSPBGA
Supplier Device Package	225-CSPBGA (13x13)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc6slx16-2csg225c

Table 3: eFUSE Programming Conditions⁽¹⁾

Symbol	Description	Min	Typ	Max	Units
$V_{FS}^{(2)}$	External voltage supply	3.2	3.3	3.4	V
I_{FS}	V_{FS} supply current	–	–	40	mA
V_{CCAUX}	Auxiliary supply voltage relative to GND	3.2	3.3	3.45	V
$R_{FUSE}^{(3)}$	External resistor from R_{FUSE} pin to GND	1129	1140	1151	Ω
V_{CCINT}	Internal supply voltage relative to GND	1.14	1.2	1.26	V
t_j	Temperature range	15	–	85	$^{\circ}\text{C}$

Notes:

- These specifications apply during programming of the eFUSE AES key. Programming is only supported through JTAG. The AES key is only supported in the following devices: LX75, LX75T, LX100, LX100T, LX150, and LX150T.
- When programming eFUSE, V_{FS} must be less than or equal to V_{CCAUX} . When not programming or when eFUSE is not used, Xilinx recommends connecting V_{FS} to GND. However, V_{FS} can be between GND and 3.45 V.
- An R_{FUSE} resistor is required when programming the eFUSE AES key. When not programming or when eFUSE is not used, Xilinx recommends connecting the R_{FUSE} pin to V_{CCAUX} or GND. However, R_{FUSE} can be unconnected.

Table 8: Recommended Operating Conditions for User I/Os Using Differential Signal Standards

I/O Standard	V _{CCO} for Drivers		
	V, Min	V, Nom	V, Max
LVDS_33	3.0	3.3	3.45
LVDS_25	2.25	2.5	2.75
BLVDS_25	2.25	2.5	2.75
MINI_LVDS_33	3.0	3.3	3.45
MINI_LVDS_25	2.25	2.5	2.75
LVPECL_33 ⁽¹⁾	N/A—Inputs Only		
LVPECL_25	N/A—Inputs Only		
RSDS_33	3.0	3.3	3.45
RSDS_25	2.25	2.5	2.75
TMDS_33 ⁽¹⁾	3.14	3.3	3.45
PPDS_33	3.0	3.3	3.45
PPDS_25	2.25	2.5	2.75
DISPLAY_PORT	2.3	2.5	2.7
DIFF_MOBILE_DDR	1.7	1.8	1.9
DIFF_HSTL_I	1.4	1.5	1.6
DIFF_HSTL_II	1.4	1.5	1.6
DIFF_HSTL_III	1.4	1.5	1.6
DIFF_HSTL_I_18	1.7	1.8	1.9
DIFF_HSTL_II_18	1.7	1.8	1.9
DIFF_HSTL_III_18	1.7	1.8	1.9
DIFF_SSTL3_I	3.0	3.3	3.45
DIFF_SSTL3_II	3.0	3.3	3.45
DIFF_SSTL2_I	2.3	2.5	2.7
DIFF_SSTL2_II	2.3	2.5	2.7
DIFF_SSTL18_I	1.7	1.8	1.9
DIFF_SSTL18_II	1.7	1.8	1.9
DIFF_SSTL15_II	1.425	1.5	1.575

Notes:

1. LVPECL_33 and TMDS_33 inputs require V_{CCAUX} = 3.3V nominal.

Table 17: GTP Transceiver Clock DC Input Level Specification

Symbol	DC Parameter	Min	Typ	Max	Units
V_{IDIFF}	Differential peak-to-peak input voltage	200	800	2000	mV
R_{IN}	Differential input resistance	80	100	120	Ω
C_{EXT}	Required external AC coupling capacitor	–	100	–	nF

GTP Transceiver Switching Characteristics

Consult [UG386](#): *Spartan-6 FPGA GTP Transceivers User Guide* for further information.

Table 18: GTP Transceiver Performance

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
F_{GTPMAX}	Maximum GTP transceiver data rate	3.2	3.2	2.7	N/A	Gb/s
$F_{GTPRANGE1}$	GTP transceiver data rate range when PLL_TXDIVSEL_OUT = 1	1.88 to 3.2	1.88 to 3.2	1.88 to 2.7	N/A	Gb/s
$F_{GTPRANGE2}$	GTP transceiver data rate range when PLL_TXDIVSEL_OUT = 2	0.94 to 1.62	0.94 to 1.62	0.94 to 1.62	N/A	Gb/s
$F_{GTPRANGE3}$	GTP transceiver data rate range when PLL_TXDIVSEL_OUT = 4	0.6 to 0.81	0.6 to 0.81	0.6 to 0.81	N/A	Gb/s
$F_{GPLLMAX}$	Maximum PLL frequency	1.62	1.62	1.62	N/A	GHz
$F_{GPLLMIN}$	Minimum PLL frequency	0.94	0.94	0.94	N/A	GHz

Table 19: GTP Transceiver Dynamic Reconfiguration Port (DRP) Switching Characteristics

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
$F_{GTPDRCLK}$	GTP transceiver DCLK (DRP clock) maximum frequency	125	125	100	N/A	MHz

Table 20: GTP Transceiver Reference Clock Switching Characteristics

Symbol	Description	Conditions	All LXT Speed Grades			Units
			Min	Typ	Max	
F_{GCLK}	Reference clock frequency range		60	–	160	MHz
T_{RCLK}	Reference clock rise time	20% – 80%	–	200	–	ps
T_{FCLK}	Reference clock fall time	80% – 20%	–	200	–	ps
T_{DCREF}	Reference clock duty cycle	Transceiver PLL only	45	50	55	%
T_{LOCK}	Clock recovery frequency acquisition time	Initial PLL lock	–	–	1	ms
T_{PHASE}	Clock recovery phase acquisition time	Lock to data after PLL has locked to the reference clock	–	–	200	μ s

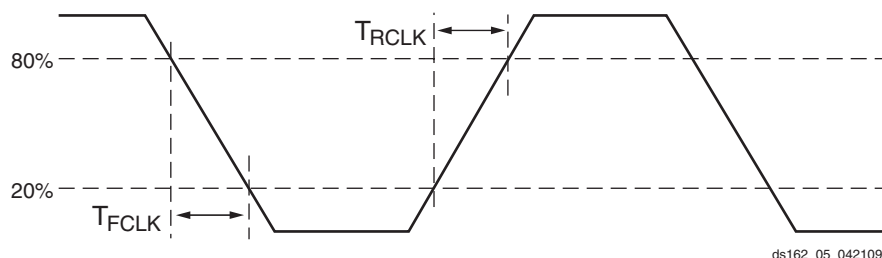


Figure 3: Reference Clock Timing Parameters

Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices (Cont'd)

I/O Standard	T _{IOPI}				T _{IOOP}				T _{IOTP}				Units
	Speed Grade				Speed Grade				Speed Grade				
	-3	-3N	-2	-1L ⁽¹⁾	-3	-3N	-2	-1L ⁽¹⁾	-3	-3N	-2	-1L ⁽¹⁾	
PPDS_33	1.17	1.29	1.42	1.68	1.57	1.71	1.91	2.43	3000	3000	3000	3000	ns
PPDS_25	1.01	1.13	1.26	1.56	1.68	1.82	2.02	2.47	3000	3000	3000	3000	ns
PCI33_3	1.07	1.19	1.32	1.57 ⁽²⁾	3.51	3.65	3.85	4.38 ⁽²⁾	3.51	3.65	3.85	4.38 ⁽¹⁾	ns
PCI66_3	1.07	1.19	1.32	1.57 ⁽²⁾	3.53	3.67	3.87	4.39 ⁽²⁾	3.53	3.67	3.87	4.39 ⁽¹⁾	ns
DISPLAY_PORT	1.02	1.14	1.27	1.56	3.15	3.29	3.49	4.08	3.15	3.29	3.49	4.08	ns
I2C	1.33	1.45	1.58	1.82	11.56	11.70	11.90	12.52	11.56	11.70	11.90	12.52	ns
SMBUS	1.33	1.45	1.58	1.82	11.56	11.70	11.90	12.52	11.56	11.70	11.90	12.52	ns
SDIO	1.36	1.48	1.61	1.84	2.64	2.78	2.98	3.60	2.64	2.78	2.98	3.60	ns
MOBILE_DDR	0.94	1.06	1.19	1.43	2.35	2.49	2.69	3.31	2.35	2.49	2.69	3.31	ns
HSTL_I	0.90	1.02	1.15	1.39	1.66	1.80	2.00	2.62	1.66	1.80	2.00	2.62	ns
HSTL_II	0.91	1.03	1.16	1.40	1.72	1.86	2.06	2.68	1.72	1.86	2.06	2.68	ns
HSTL_III	0.95	1.07	1.20	1.44	1.67	1.81	2.01	2.61	1.67	1.81	2.01	2.61	ns
HSTL_I_18	0.94	1.06	1.19	1.43	1.77	1.91	2.11	2.73	1.77	1.91	2.11	2.73	ns
HSTL_II_18	0.94	1.06	1.19	1.43	1.85	1.99	2.19	2.81	1.85	1.99	2.19	2.81	ns
HSTL_III_18	0.99	1.11	1.24	1.47	1.79	1.93	2.13	2.72	1.79	1.93	2.13	2.72	ns
SSTL3_I	1.58	1.70	1.83	2.16	1.83	1.97	2.17	2.72	1.83	1.97	2.17	2.72	ns
SSTL3_II	1.58	1.70	1.83	2.16	2.01	2.15	2.35	2.94	2.01	2.15	2.35	2.94	ns
SSTL2_I	1.30	1.42	1.55	1.87	1.77	1.91	2.11	2.69	1.77	1.91	2.11	2.69	ns
SSTL2_II	1.30	1.42	1.55	1.88	1.86	2.00	2.20	2.82	1.86	2.00	2.20	2.82	ns
SSTL18_I	0.92	1.04	1.17	1.41	1.63	1.77	1.97	2.59	1.63	1.77	1.97	2.59	ns
SSTL18_II	0.92	1.04	1.17	1.41	1.66	1.80	2.00	2.62	1.66	1.80	2.00	2.62	ns
SSTL15_II	0.92	1.04	1.17	1.41	1.67	1.81	2.01	2.63	1.67	1.81	2.01	2.63	ns
DIFF_HSTL_I	0.94	1.06	1.19	1.46	1.77	1.91	2.11	2.62	1.77	1.91	2.11	2.62	ns
DIFF_HSTL_II	0.93	1.05	1.18	1.45	1.72	1.86	2.06	2.54	1.72	1.86	2.06	2.54	ns
DIFF_HSTL_III	0.93	1.05	1.18	1.46	1.69	1.83	2.03	2.53	1.69	1.83	2.03	2.53	ns
DIFF_HSTL_I_18	0.97	1.09	1.22	1.50	1.79	1.93	2.13	2.63	1.79	1.93	2.13	2.63	ns
DIFF_HSTL_II_18	0.97	1.09	1.22	1.49	1.69	1.83	2.03	2.51	1.69	1.83	2.03	2.51	ns
DIFF_HSTL_III_18	0.97	1.09	1.22	1.50	1.69	1.83	2.03	2.53	1.69	1.83	2.03	2.53	ns
DIFF_SSTL3_I	1.18	1.30	1.43	1.68	1.81	1.95	2.15	2.64	1.81	1.95	2.15	2.64	ns
DIFF_SSTL3_II	1.19	1.31	1.44	1.68	1.80	1.94	2.14	2.63	1.80	1.94	2.14	2.63	ns
DIFF_SSTL2_I	1.02	1.14	1.27	1.57	1.80	1.94	2.14	2.62	1.80	1.94	2.14	2.62	ns
DIFF_SSTL2_II	1.02	1.14	1.27	1.57	1.76	1.90	2.10	2.57	1.76	1.90	2.10	2.57	ns
DIFF_SSTL18_I	0.97	1.09	1.22	1.51	1.72	1.86	2.06	2.56	1.72	1.86	2.06	2.56	ns
DIFF_SSTL18_II	0.98	1.10	1.23	1.50	1.68	1.82	2.02	2.52	1.68	1.82	2.02	2.52	ns
DIFF_SSTL15_II	0.94	1.06	1.19	1.46	1.67	1.81	2.01	2.50	1.67	1.81	2.01	2.50	ns
DIFF_MOBILE_DDR	0.97	1.09	1.22	1.51	1.75	1.89	2.09	2.57	1.75	1.89	2.09	2.57	ns

Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices (Cont'd)

I/O Standard	T _{IOPI}				T _{IOOP}				T _{IOTP}				Units
	Speed Grade				Speed Grade				Speed Grade				
	-3	-3N	-2	-1L ⁽¹⁾	-3	-3N	-2	-1L ⁽¹⁾	-3	-3N	-2	-1L ⁽¹⁾	
LVTTL, QUIETIO, 2 mA	1.35	1.47	1.60	1.82	5.39	5.53	5.73	6.37	5.39	5.53	5.73	6.37	ns
LVTTL, QUIETIO, 4 mA	1.35	1.47	1.60	1.82	4.29	4.43	4.63	5.22	4.29	4.43	4.63	5.22	ns
LVTTL, QUIETIO, 6 mA	1.35	1.47	1.60	1.82	3.75	3.89	4.09	4.69	3.75	3.89	4.09	4.69	ns
LVTTL, QUIETIO, 8 mA	1.35	1.47	1.60	1.82	3.23	3.37	3.57	4.20	3.23	3.37	3.57	4.20	ns
LVTTL, QUIETIO, 12 mA	1.35	1.47	1.60	1.82	3.28	3.42	3.62	4.22	3.28	3.42	3.62	4.22	ns
LVTTL, QUIETIO, 16 mA	1.35	1.47	1.60	1.82	2.94	3.08	3.28	3.92	2.94	3.08	3.28	3.92	ns
LVTTL, QUIETIO, 24 mA	1.35	1.47	1.60	1.82	2.69	2.83	3.03	3.67	2.69	2.83	3.03	3.67	ns
LVTTL, Slow, 2 mA	1.35	1.47	1.60	1.82	4.36	4.50	4.70	5.30	4.36	4.50	4.70	5.30	ns
LVTTL, Slow, 4 mA	1.35	1.47	1.60	1.82	3.17	3.31	3.51	4.16	3.17	3.31	3.51	4.16	ns
LVTTL, Slow, 6 mA	1.35	1.47	1.60	1.82	2.76	2.90	3.10	3.75	2.76	2.90	3.10	3.75	ns
LVTTL, Slow, 8 mA	1.35	1.47	1.60	1.82	2.59	2.73	2.93	3.55	2.59	2.73	2.93	3.55	ns
LVTTL, Slow, 12 mA	1.35	1.47	1.60	1.82	2.58	2.72	2.92	3.54	2.58	2.72	2.92	3.54	ns
LVTTL, Slow, 16 mA	1.35	1.47	1.60	1.82	2.39	2.53	2.73	3.40	2.39	2.53	2.73	3.40	ns
LVTTL, Slow, 24 mA	1.35	1.47	1.60	1.82	2.28	2.42	2.62	3.24	2.28	2.42	2.62	3.24	ns
LVTTL, Fast, 2 mA	1.35	1.47	1.60	1.82	3.78	3.92	4.12	4.74	3.78	3.92	4.12	4.74	ns
LVTTL, Fast, 4 mA	1.35	1.47	1.60	1.82	2.49	2.63	2.83	3.45	2.49	2.63	2.83	3.45	ns
LVTTL, Fast, 6 mA	1.35	1.47	1.60	1.82	2.44	2.58	2.78	3.40	2.44	2.58	2.78	3.40	ns
LVTTL, Fast, 8 mA	1.35	1.47	1.60	1.82	2.32	2.46	2.66	3.28	2.32	2.46	2.66	3.28	ns
LVTTL, Fast, 12 mA	1.35	1.47	1.60	1.82	1.83	1.97	2.17	2.79	1.83	1.97	2.17	2.79	ns
LVTTL, Fast, 16 mA	1.35	1.47	1.60	1.82	1.83	1.97	2.17	2.79	1.83	1.97	2.17	2.79	ns
LVTTL, Fast, 24 mA	1.35	1.47	1.60	1.82	1.83	1.97	2.17	2.79	1.83	1.97	2.17	2.79	ns
LVC MOS33, QUIETIO, 2 mA	1.34	1.46	1.59	1.82	5.40	5.54	5.74	6.37	5.40	5.54	5.74	6.37	ns
LVC MOS33, QUIETIO, 4 mA	1.34	1.46	1.59	1.82	4.03	4.17	4.37	5.01	4.03	4.17	4.37	5.01	ns
LVC MOS33, QUIETIO, 6 mA	1.34	1.46	1.59	1.82	3.51	3.65	3.85	4.47	3.51	3.65	3.85	4.47	ns
LVC MOS33, QUIETIO, 8 mA	1.34	1.46	1.59	1.82	3.37	3.51	3.71	4.33	3.37	3.51	3.71	4.33	ns
LVC MOS33, QUIETIO, 12 mA	1.34	1.46	1.59	1.82	2.94	3.08	3.28	3.93	2.94	3.08	3.28	3.93	ns
LVC MOS33, QUIETIO, 16 mA	1.34	1.46	1.59	1.82	2.77	2.91	3.11	3.78	2.77	2.91	3.11	3.78	ns
LVC MOS33, QUIETIO, 24 mA	1.34	1.46	1.59	1.82	2.59	2.73	2.93	3.58	2.59	2.73	2.93	3.58	ns
LVC MOS33, Slow, 2 mA	1.34	1.46	1.59	1.82	4.37	4.51	4.71	5.28	4.37	4.51	4.71	5.28	ns
LVC MOS33, Slow, 4 mA	1.34	1.46	1.59	1.82	2.98	3.12	3.32	3.94	2.98	3.12	3.32	3.94	ns
LVC MOS33, Slow, 6 mA	1.34	1.46	1.59	1.82	2.58	2.72	2.92	3.61	2.58	2.72	2.92	3.61	ns
LVC MOS33, Slow, 8 mA	1.34	1.46	1.59	1.82	2.65	2.79	2.99	3.61	2.65	2.79	2.99	3.61	ns
LVC MOS33, Slow, 12 mA	1.34	1.46	1.59	1.82	2.39	2.53	2.73	3.31	2.39	2.53	2.73	3.31	ns
LVC MOS33, Slow, 16 mA	1.34	1.46	1.59	1.82	2.31	2.45	2.65	3.27	2.31	2.45	2.65	3.27	ns
LVC MOS33, Slow, 24 mA	1.34	1.46	1.59	1.82	2.28	2.42	2.62	3.24	2.28	2.42	2.62	3.24	ns
LVC MOS33, Fast, 2 mA	1.34	1.46	1.59	1.82	3.76	3.90	4.10	4.70	3.76	3.90	4.10	4.70	ns
LVC MOS33, Fast, 4 mA	1.34	1.46	1.59	1.82	2.48	2.62	2.82	3.44	2.48	2.62	2.82	3.44	ns
LVC MOS33, Fast, 6 mA	1.34	1.46	1.59	1.82	2.32	2.46	2.66	3.28	2.32	2.46	2.66	3.28	ns

Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices (Cont'd)

I/O Standard	T _{IOPI}				T _{IOOP}				T _{IOTP}				Units
	Speed Grade				Speed Grade				Speed Grade				
	-3	-3N	-2	-1L ⁽¹⁾	-3	-3N	-2	-1L ⁽¹⁾	-3	-3N	-2	-1L ⁽¹⁾	
LVC MOS18, Slow, 24 mA	1.18	1.30	1.43	2.04	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns
LVC MOS18, Fast, 2 mA	1.18	1.30	1.43	2.04	3.59	3.73	3.93	4.53	3.59	3.73	3.93	4.53	ns
LVC MOS18, Fast, 4 mA	1.18	1.30	1.43	2.04	2.39	2.53	2.73	3.35	2.39	2.53	2.73	3.35	ns
LVC MOS18, Fast, 6 mA	1.18	1.30	1.43	2.04	1.88	2.02	2.22	2.84	1.88	2.02	2.22	2.84	ns
LVC MOS18, Fast, 8 mA	1.18	1.30	1.43	2.04	1.81	1.95	2.15	2.77	1.81	1.95	2.15	2.77	ns
LVC MOS18, Fast, 12 mA	1.18	1.30	1.43	2.04	1.71	1.85	2.05	2.67	1.71	1.85	2.05	2.67	ns
LVC MOS18, Fast, 16 mA	1.18	1.30	1.43	2.04	1.71	1.85	2.05	2.67	1.71	1.85	2.05	2.67	ns
LVC MOS18, Fast, 24 mA	1.18	1.30	1.43	2.04	1.71	1.85	2.05	2.67	1.71	1.85	2.05	2.67	ns
LVC MOS18_JEDEC, QUIETIO, 2 mA	0.94	1.06	1.19	1.41	5.91	6.05	6.25	6.79	5.91	6.05	6.25	6.79	ns
LVC MOS18_JEDEC, QUIETIO, 4 mA	0.94	1.06	1.19	1.41	4.75	4.89	5.09	5.64	4.75	4.89	5.09	5.64	ns
LVC MOS18_JEDEC, QUIETIO, 6 mA	0.94	1.06	1.19	1.41	4.04	4.18	4.38	4.96	4.04	4.18	4.38	4.96	ns
LVC MOS18_JEDEC, QUIETIO, 8 mA	0.94	1.06	1.19	1.41	3.71	3.85	4.05	4.62	3.71	3.85	4.05	4.62	ns
LVC MOS18_JEDEC, QUIETIO, 12 mA	0.94	1.06	1.19	1.41	3.35	3.49	3.69	4.28	3.35	3.49	3.69	4.28	ns
LVC MOS18_JEDEC, QUIETIO, 16 mA	0.94	1.06	1.19	1.41	3.20	3.34	3.54	4.13	3.20	3.34	3.54	4.13	ns
LVC MOS18_JEDEC, QUIETIO, 24 mA	0.94	1.06	1.19	1.41	2.96	3.10	3.30	3.98	2.96	3.10	3.30	3.98	ns
LVC MOS18_JEDEC, Slow, 2 mA	0.94	1.06	1.19	1.41	4.59	4.73	4.93	5.54	4.59	4.73	4.93	5.54	ns
LVC MOS18_JEDEC, Slow, 4 mA	0.94	1.06	1.19	1.41	3.69	3.83	4.03	4.60	3.69	3.83	4.03	4.60	ns
LVC MOS18_JEDEC, Slow, 6 mA	0.94	1.06	1.19	1.41	3.00	3.14	3.34	3.94	3.00	3.14	3.34	3.94	ns
LVC MOS18_JEDEC, Slow, 8 mA	0.94	1.06	1.19	1.41	2.19	2.33	2.53	3.18	2.19	2.33	2.53	3.18	ns
LVC MOS18_JEDEC, Slow, 12 mA	0.94	1.06	1.19	1.41	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns
LVC MOS18_JEDEC, Slow, 16 mA	0.94	1.06	1.19	1.41	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns
LVC MOS18_JEDEC, Slow, 24 mA	0.94	1.06	1.19	1.41	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns
LVC MOS18_JEDEC, Fast, 2 mA	0.94	1.06	1.19	1.41	3.57	3.71	3.91	4.52	3.57	3.71	3.91	4.52	ns
LVC MOS18_JEDEC, Fast, 4 mA	0.94	1.06	1.19	1.41	2.39	2.53	2.73	3.35	2.39	2.53	2.73	3.35	ns
LVC MOS18_JEDEC, Fast, 6 mA	0.94	1.06	1.19	1.41	1.88	2.02	2.22	2.84	1.88	2.02	2.22	2.84	ns
LVC MOS18_JEDEC, Fast, 8 mA	0.94	1.06	1.19	1.41	1.80	1.94	2.14	2.76	1.80	1.94	2.14	2.76	ns
LVC MOS18_JEDEC, Fast, 12 mA	0.94	1.06	1.19	1.41	1.72	1.86	2.06	2.68	1.72	1.86	2.06	2.68	ns
LVC MOS18_JEDEC, Fast, 16 mA	0.94	1.06	1.19	1.41	1.72	1.86	2.06	2.68	1.72	1.86	2.06	2.68	ns
LVC MOS18_JEDEC, Fast, 24 mA	0.94	1.06	1.19	1.41	1.72	1.86	2.06	2.68	1.72	1.86	2.06	2.68	ns
LVC MOS15, QUIETIO, 2 mA	0.98	1.10	1.23	1.79	5.47	5.61	5.81	6.38	5.47	5.61	5.81	6.38	ns
LVC MOS15, QUIETIO, 4 mA	0.98	1.10	1.23	1.79	4.61	4.75	4.95	5.51	4.61	4.75	4.95	5.51	ns
LVC MOS15, QUIETIO, 6 mA	0.98	1.10	1.23	1.79	4.07	4.21	4.41	4.97	4.07	4.21	4.41	4.97	ns
LVC MOS15, QUIETIO, 8 mA	0.98	1.10	1.23	1.79	3.91	4.05	4.25	4.81	3.91	4.05	4.25	4.81	ns
LVC MOS15, QUIETIO, 12 mA	0.98	1.10	1.23	1.79	3.53	3.67	3.87	4.51	3.53	3.67	3.87	4.51	ns
LVC MOS15, QUIETIO, 16 mA	0.98	1.10	1.23	1.79	3.32	3.46	3.66	4.31	3.32	3.46	3.66	4.31	ns
LVC MOS15, Slow, 2 mA	0.98	1.10	1.23	1.79	4.18	4.32	4.52	5.11	4.18	4.32	4.52	5.11	ns
LVC MOS15, Slow, 4 mA	0.98	1.10	1.23	1.79	3.42	3.56	3.76	4.34	3.42	3.56	3.76	4.34	ns
LVC MOS15, Slow, 6 mA	0.98	1.10	1.23	1.79	2.29	2.43	2.63	3.24	2.29	2.43	2.63	3.24	ns

Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices (Cont'd)

I/O Standard	T _{IOPI}				T _{IOOP}				T _{IOTP}				Units
	Speed Grade				Speed Grade				Speed Grade				
	-3	-3N	-2	-1L ⁽¹⁾	-3	-3N	-2	-1L ⁽¹⁾	-3	-3N	-2	-1L ⁽¹⁾	
LVC MOS12, Fast, 2 mA	0.91	1.03	1.16	1.51	3.46	3.60	3.80	4.44	3.46	3.60	3.80	4.44	ns
LVC MOS12, Fast, 4 mA	0.91	1.03	1.16	1.51	2.35	2.49	2.69	3.30	2.35	2.49	2.69	3.30	ns
LVC MOS12, Fast, 6 mA	0.91	1.03	1.16	1.51	1.79	1.93	2.13	2.75	1.79	1.93	2.13	2.75	ns
LVC MOS12, Fast, 8 mA	0.91	1.03	1.16	1.51	1.68	1.82	2.02	2.64	1.68	1.82	2.02	2.64	ns
LVC MOS12, Fast, 12 mA	0.91	1.03	1.16	1.51	1.66	1.80	2.00	2.62	1.66	1.80	2.00	2.62	ns
LVC MOS12_JEDEC, QUIETIO, 2 mA	1.50	1.62	1.75	1.88	6.39	6.53	6.73	7.31	6.39	6.53	6.73	7.31	ns
LVC MOS12_JEDEC, QUIETIO, 4 mA	1.50	1.62	1.75	1.88	4.98	5.12	5.32	5.88	4.98	5.12	5.32	5.88	ns
LVC MOS12_JEDEC, QUIETIO, 6 mA	1.50	1.62	1.75	1.88	4.67	4.81	5.01	5.54	4.67	4.81	5.01	5.54	ns
LVC MOS12_JEDEC, QUIETIO, 8 mA	1.50	1.62	1.75	1.88	4.23	4.37	4.57	5.22	4.23	4.37	4.57	5.22	ns
LVC MOS12_JEDEC, QUIETIO, 12 mA	1.50	1.62	1.75	1.88	3.99	4.13	4.33	4.94	3.99	4.13	4.33	4.94	ns
LVC MOS12_JEDEC, Slow, 2 mA	1.50	1.62	1.75	1.88	5.00	5.14	5.34	5.90	5.00	5.14	5.34	5.90	ns
LVC MOS12_JEDEC, Slow, 4 mA	1.50	1.62	1.75	1.88	2.85	2.99	3.19	3.80	2.85	2.99	3.19	3.80	ns
LVC MOS12_JEDEC, Slow, 6 mA	1.50	1.62	1.75	1.88	2.76	2.90	3.10	3.72	2.76	2.90	3.10	3.72	ns
LVC MOS12_JEDEC, Slow, 8 mA	1.50	1.62	1.75	1.88	2.35	2.49	2.69	3.30	2.35	2.49	2.69	3.30	ns
LVC MOS12_JEDEC, Slow, 12 mA	1.50	1.62	1.75	1.88	2.09	2.23	2.43	3.05	2.09	2.23	2.43	3.05	ns
LVC MOS12_JEDEC, Fast, 2 mA	1.50	1.62	1.75	1.88	3.46	3.60	3.80	4.42	3.46	3.60	3.80	4.42	ns
LVC MOS12_JEDEC, Fast, 4 mA	1.50	1.62	1.75	1.88	2.35	2.49	2.69	3.31	2.35	2.49	2.69	3.31	ns
LVC MOS12_JEDEC, Fast, 6 mA	1.50	1.62	1.75	1.88	1.79	1.93	2.13	2.76	1.79	1.93	2.13	2.76	ns
LVC MOS12_JEDEC, Fast, 8 mA	1.50	1.62	1.75	1.88	1.69	1.83	2.03	2.65	1.69	1.83	2.03	2.65	ns
LVC MOS12_JEDEC, Fast, 12 mA	1.50	1.62	1.75	1.88	1.66	1.80	2.00	2.62	1.66	1.80	2.00	2.62	ns

Notes:

1. The -1L values listed in this table are also applicable to the Spartan-6Q devices.
2. Devices with a -1L speed grade do not support Xilinx PCI IP.

Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices⁽¹⁾ (Cont'd)

I/O Standard	T _{IOPI}		T _{IOOP}		T _{IOTP}		Units
	Speed Grade		Speed Grade		Speed Grade		
	-3	-2	-3	-2	-3	-2	
DIFF_SSTL3_I	1.26	1.44	1.95	2.15	1.95	2.15	ns
DIFF_SSTL3_II	1.26	1.44	1.94	2.14	1.94	2.14	ns
DIFF_SSTL2_I	1.09	1.27	1.94	2.14	1.94	2.14	ns
DIFF_SSTL2_II	1.09	1.27	1.90	2.10	1.90	2.10	ns
DIFF_SSTL18_I	1.04	1.22	1.86	2.06	1.86	2.06	ns
DIFF_SSTL18_II	1.05	1.23	1.82	2.02	1.82	2.02	ns
DIFF_SSTL15_II	1.01	1.19	1.81	2.01	1.81	2.01	ns
DIFF_MOBILE_DDR	1.04	1.22	1.89	2.09	1.89	2.09	ns
LVTTL, QUIETIO, 2 mA	1.42	1.60	5.64	5.84	5.64	5.84	ns
LVTTL, QUIETIO, 4 mA	1.42	1.60	4.46	4.66	4.46	4.66	ns
LVTTL, QUIETIO, 6 mA	1.42	1.60	3.92	4.12	3.92	4.12	ns
LVTTL, QUIETIO, 8 mA	1.42	1.60	3.37	3.57	3.37	3.57	ns
LVTTL, QUIETIO, 12 mA	1.42	1.60	3.42	3.62	3.42	3.62	ns
LVTTL, QUIETIO, 16 mA	1.42	1.60	3.09	3.29	3.09	3.29	ns
LVTTL, QUIETIO, 24 mA	1.42	1.60	2.83	3.03	2.83	3.03	ns
LVTTL, Slow, 2 mA	1.42	1.60	4.58	4.78	4.58	4.78	ns
LVTTL, Slow, 4 mA	1.42	1.60	3.38	3.58	3.38	3.58	ns
LVTTL, Slow, 6 mA	1.42	1.60	2.95	3.15	2.95	3.15	ns
LVTTL, Slow, 8 mA	1.42	1.60	2.73	2.93	2.73	2.93	ns
LVTTL, Slow, 12 mA	1.42	1.60	2.72	2.92	2.72	2.92	ns
LVTTL, Slow, 16 mA	1.42	1.60	2.53	2.73	2.53	2.73	ns
LVTTL, Slow, 24 mA	1.42	1.60	2.42	2.62	2.42	2.62	ns
LVTTL, Fast, 2 mA	1.42	1.60	4.04	4.24	4.04	4.24	ns
LVTTL, Fast, 4 mA	1.42	1.60	2.66	2.86	2.66	2.86	ns
LVTTL, Fast, 6 mA	1.42	1.60	2.58	2.78	2.58	2.78	ns
LVTTL, Fast, 8 mA	1.42	1.60	2.46	2.66	2.46	2.66	ns
LVTTL, Fast, 12 mA	1.42	1.60	1.97	2.17	1.97	2.17	ns
LVTTL, Fast, 16 mA	1.42	1.60	1.97	2.17	1.97	2.17	ns
LVTTL, Fast, 24 mA	1.42	1.60	1.97	2.17	1.97	2.17	ns
LVC MOS33, QUIETIO, 2 mA	1.41	1.59	5.65	5.85	5.65	5.85	ns
LVC MOS33, QUIETIO, 4 mA	1.41	1.59	4.20	4.40	4.20	4.40	ns
LVC MOS33, QUIETIO, 6 mA	1.41	1.59	3.65	3.85	3.65	3.85	ns
LVC MOS33, QUIETIO, 8 mA	1.41	1.59	3.51	3.71	3.51	3.71	ns
LVC MOS33, QUIETIO, 12 mA	1.41	1.59	3.09	3.29	3.09	3.29	ns
LVC MOS33, QUIETIO, 16 mA	1.41	1.59	2.91	3.11	2.91	3.11	ns
LVC MOS33, QUIETIO, 24 mA	1.41	1.59	2.73	2.93	2.73	2.93	ns
LVC MOS33, Slow, 2 mA	1.41	1.59	4.59	4.79	4.59	4.79	ns
LVC MOS33, Slow, 4 mA	1.41	1.59	3.14	3.34	3.14	3.34	ns

I/O Standard Measurement Methodology

Input Delay Measurements

Table 31 shows the test setup parameters used for measuring input delay.

Table 31: Input Delay Measurement Methodology

Description	I/O Standard Attribute	$V_L^{(1)}$	$V_H^{(1)}$	$V_{MEAS}^{(3)(4)}$	$V_{REF}^{(2)(4)}$
LVTTTL (Low-Voltage Transistor-Transistor Logic)	LVTTTL	0	3.0	1.4	—
LVC MOS (Low-Voltage CMOS), 3.3V	LVC MOS33	0	3.3	1.65	—
LVC MOS, 2.5V	LVC MOS25	0	2.5	1.25	—
LVC MOS, 1.8V	LVC MOS18	0	1.8	0.9	—
LVC MOS, 1.5V	LVC MOS15	0	1.5	0.75	—
LVC MOS, 1.2V	LVC MOS12	0	1.2	0.6	—
PCI (Peripheral Component Interface), 33 MHz and 66 MHz, 3.3V	PCI33_3, PCI66_3	Per PCI Specification			—
HSTL (High-Speed Transceiver Logic), Class I & II	HSTL_I, HSTL_II	$V_{REF} - 0.5$	$V_{REF} + 0.5$	V_{REF}	0.75
HSTL, Class III	HSTL_III	$V_{REF} - 0.5$	$V_{REF} + 0.5$	V_{REF}	0.90
HSTL, Class I & II, 1.8V	HSTL_I_18, HSTL_II_18	$V_{REF} - 0.5$	$V_{REF} + 0.5$	V_{REF}	0.90
HSTL, Class III 1.8V	HSTL_III_18	$V_{REF} - 0.5$	$V_{REF} + 0.5$	V_{REF}	1.1
SSTL (Stub Terminated Transceiver Logic), Class I & II, 3.3V	SSTL3_I, SSTL3_II	$V_{REF} - 0.75$	$V_{REF} + 0.75$	V_{REF}	1.5
SSTL, Class I & II, 2.5V	SSTL2_I, SSTL2_II	$V_{REF} - 0.75$	$V_{REF} + 0.75$	V_{REF}	1.25
SSTL, Class I & II, 1.8V	SSTL18_I, SSTL18_II	$V_{REF} - 0.5$	$V_{REF} + 0.5$	V_{REF}	0.90
SSTL, Class II, 1.5V	SSTL15_II	$V_{REF} - 0.2$	$V_{REF} + 0.2$	V_{REF}	0.75
LVDS (Low-Voltage Differential Signaling), 2.5V & 3.3V	LVDS_25, LVDS_33	$1.25 - 0.125$	$1.25 + 0.125$	0 ⁽⁵⁾	—
LVPECL (Low-Voltage Positive Emitter-Coupled Logic), 2.5V & 3.3V	LVPECL_25, LVPECL_33	$1.2 - 0.3$	$1.2 + 0.3$	0 ⁽⁵⁾	—
BLVDS (Bus LVDS), 2.5V	BLVDS_25	$1.3 - 0.125$	$1.3 + 0.125$	0 ⁽⁵⁾	—
Mini-LVDS, 2.5V & 3.3V	MINI_LVDS_25, MINI_LVDS_33	$1.2 - 0.125$	$1.2 + 0.125$	0 ⁽⁵⁾	—
RS DS (Reduced Swing Differential Signaling), 2.5V & 3.3V	RS DS_25, RS DS_33	$1.2 - 0.1$	$1.2 + 0.1$	0 ⁽⁵⁾	—
TMDS (Transition Minimized Differential Signaling), 3.3V	TMDS_33	$3.0 - 0.1$	$3.0 + 0.1$	0 ⁽⁵⁾	—
PPDS (Point-to-Point Differential Signaling), 2.5V & 3.3V	PPDS_25, PPDS_33	$1.25 - 0.1$	$1.25 + 0.1$	0 ⁽⁵⁾	—

Notes:

1. Input waveform switches between V_L and V_H .
2. Measurements are made at typical, minimum, and maximum V_{REF} values. Reported delays reflect worst case of these measurements. V_{REF} values listed are typical.
3. Input voltage level from which measurement starts.
4. This is an input voltage reference that bears no relation to the V_{REF} / V_{MEAS} parameters found in IBIS models and/or noted in Figure 4.
5. The value given is the differential input voltage.

Table 34: SSO Limit per V_{CCO}/GND Pair

V_{CCO}	I/O Standard	Drive	Slew	SSO Limit per V_{CCO}/GND Pair			
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324	
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5
1.2V	LVCMOS12, LVCMOS12_JEDEC	2	Fast	30 ⁽¹⁾	35	30	35
			Slow	51	55	51	52
			QuietIO	71	58	71	70
		4	Fast	17	17	17	19
			Slow	23	25	23	22
			QuietIO	35	32	35	32
		6	Fast	13	15	13	14
			Slow	19	20	19	17
			QuietIO	26	24	26	24
		8	Fast	N/A	12	N/A	12
			Slow	N/A	15	N/A	13
			QuietIO	N/A	20	N/A	19
		12	Fast	N/A	5	N/A	4
			Slow	N/A	8	N/A	5
			QuietIO	N/A	11	N/A	10

Table 34: SSO Limit per V_{CCO}/GND Pair (Cont'd)

V _{CCO}	I/O Standard	Drive	Slew	SSO Limit per V _{CCO} /GND Pair			
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324	
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5
1.5V	LVCMOS15, LVCMOS15_JEDEC	2	Fast	33	40	33	41
			Slow	57	62	57	56
			QuietIO	70	67	70	66
		4	Fast	19	21	19	21
			Slow	30	30	30	24
			QuietIO	38	33	38	30
		6	Fast	14	16	14	16
			Slow	18	19	18	17
			QuietIO	27	24	27	21
		8	Fast	11	13	11	12
			Slow	16	16	16	14
			QuietIO	23	20	23	17
		12	Fast	N/A	5	N/A	4
			Slow	N/A	8	N/A	5
			QuietIO	N/A	10	N/A	9
		16	Fast	N/A	5	N/A	4
			Slow	N/A	8	N/A	8
			QuietIO	N/A	10	N/A	9
	HSTL_I			9	10	9	10
	HSTL_II			N/A	5	N/A	6
	HSTL_III			7	9	7	9
	DIFF_HSTL_I			27	30	27	30
	DIFF_HSTL_II			N/A	15	N/A	18
	DIFF_HSTL_III			21	27	21	27
	SSTL_15_II ⁽³⁾			N/A	5	N/A	4
	DIFF_SSTL_15_II ⁽³⁾			N/A	15	N/A	12

Table 34: SSO Limit per V_{CCO}/GND Pair (Cont'd)

V _{CCO}	I/O Standard	Drive	Slew	SSO Limit per V _{CCO} /GND Pair					
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324			
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5		
2.5V	LVCMOS25	2	Fast	38	43	38	43		
			Slow	46	52	46	48		
			QuietIO	57	64	57	59		
		4	Fast	21	24	21	23		
			Slow	26	31	26	27		
			QuietIO	33	32	33	30		
		6	Fast	15	17	15	16		
			Slow	19	22	19	19		
			QuietIO	25	23	25	19		
		8	Fast	12	15	12	14		
			Slow	15	18	15	16		
			QuietIO	21	19	21	16		
		12	Fast	1	3	1	1		
			Slow	2	7	2	4		
			QuietIO	3	8	3	8		
		16	Fast	1	3	1	1		
			Slow	3	7	3	3		
			QuietIO	4	9	4	8		
		24	Fast	N/A	3	N/A	1		
			Slow	N/A	5	N/A	2		
			QuietIO	N/A	8	N/A	6		
		SSTL_2_I ⁽³⁾				10	11	10	11
		SSTL_2_II ⁽³⁾				N/A	7	N/A	7
		DIFF_SSTL_2_I ⁽³⁾				30	33	30	33
	DIFF_SSTL_2_II ⁽³⁾				N/A	21	N/A	24	

Clock Buffers and Networks

Table 48: Global Clock Switching Characteristics (BUFGMUX)

Symbol	Description	Devices	Speed Grade				Units
			-3	-3N	-2	-1L	
T _{GSI}	S pin Setup to I0/I1 inputs	LX devices	0.25	0.31	0.48	0.48	ns
		LXT devices	0.25	0.31	0.48	N/A	ns
T _{GIO}	BUFGMUX delay from I0/I1 to O	LX devices	0.21	0.21	0.21	0.21	ns
		LXT devices	0.21	0.21	0.21	N/A	ns
Maximum Frequency							
F _{MAX}	Global clock tree (BUFGMUX)	LX devices	400	400	375	250	MHz
		LXT devices	400	400	375	N/A	MHz

Table 49: Input/Output Clock Switching Characteristics (BUFIO2)

Symbol	Description	Devices	Speed Grade				Units
			-3	-3N	-2	-1L	
T _{BUFCO_O}	Clock to out delay from I to O	LX devices	0.67	0.82	1.09	1.50	ns
		LXT devices	0.67	0.82	1.09	N/A	ns
Maximum Frequency							
F _{MAX}	I/O clock tree (BUFIO2)	LX devices	540	525	500	300	MHz
		LXT devices	540	525	500	N/A	MHz

Table 50: Input/Output Clock Switching Characteristics (BUFIO2FB)

Symbol	Description	Devices	Speed Grade				Units
			-3	-3N	-2	-1L	
Maximum Frequency							
F _{MAX}	I/O clock tree (BUFIO2FB)	LX devices	1080	1050	950	500	MHz
		LXT devices	1080	1050	950	N/A	MHz

Table 51: Input/Output Clock Switching Characteristics (BUFPLL)

Symbol	Description	Devices	Speed Grade				Units
			-3	-3N	-2	-1L	
Maximum Frequency							
F _{MAX}	BUFPLL clock tree (BUFPLL)	LX devices	1080	1050	950	500	MHz
		LXT devices	1080	1050	950	N/A	MHz

PLL Switching Characteristics

Table 52: PLL Specification

Symbol	Description	Device ⁽¹⁾	Speed Grade				Units
			-3	-3N	-2	-1L	
F_{INMAX}	Maximum Input Clock Frequency from I/O Clock	LX devices	540	525	450	300	MHz
		LXT devices	540	525	450	N/A	MHz
	Maximum Input Clock Frequency from Global Clock	LX devices	400	400	375	250	MHz
		LXT devices	400	400	375	N/A	MHz

Table 52: PLL Specification (Cont'd)

Symbol	Description	Device ⁽¹⁾	Speed Grade				Units
			-3	-3N	-2	-1L	
F _{INMIN}	Minimum Input Clock Frequency	LX devices	19	19	19	19	MHz
		LXT devices	19	19	19	N/A	MHz
F _{INJITTER}	Maximum Input Clock Period Jitter: 19–200 MHz	All	1 ns Maximum				
	Maximum Input Clock Period Jitter: > 200 MHz	All	<20% of clock input period Maximum				
F _{INDUTY}	Allowable Input Duty Cycle: 19—199 MHz	All	25/75				%
	Allowable Input Duty Cycle: 200—299 MHz	All	35/65				%
	Allowable Input Duty Cycle: > 300 MHz	All	45/55				%
F _{VCOMIN}	Minimum PLL VCO Frequency	LX devices	400	400	400	400	MHz
		LXT devices	400	400	400	N/A	MHz
F _{VCOMAX}	Maximum PLL VCO Frequency	LX devices	1080	1050	1000	1000	MHz
		LXT devices	1080	1050	1000	N/A	MHz
F _{BANDWIDTH}	Low PLL Bandwidth at Typical ⁽³⁾	All	1	1	1	1	MHz
	High PLL Bandwidth at Typical ⁽³⁾	All	4	4	4	4	MHz
T _{STAPHAOFFSET}	Static Phase Offset of the PLL Outputs	All	0.12	0.12	0.12	0.15	ns
T _{OUTJITTER}	PLL Output Jitter ⁽³⁾	All	Note 2				
T _{OUTDUTY}	PLL Output Clock Duty Cycle Precision ⁽⁴⁾	All	0.15	0.15	0.20	0.25	ns
T _{LOCKMAX}	PLL Maximum Lock Time	All	100	100	100	100	µs
F _{OUTMAX}	PLL Maximum Output Frequency for BUFGMUX	LX devices	400	400	375	250	MHz
		LXT devices	400	400	375	N/A	MHz
	PLL Maximum Output Frequency for BUFPLL	LX devices	1080	1050	950	500	MHz
		LXT devices	1080	1050	950	N/A	MHz
F _{OUTMIN}	PLL Minimum Output Frequency ⁽⁵⁾	All	3.125	3.125	3.125	3.125	MHz
T _{EXTFDVAR}	External Clock Feedback Variation: 19–200 MHz	All	1 ns Maximum				
	External Clock Feedback Variation: > 200 MHz	All	< 20% of clock input period Maximum				
RST _{MINPULSE}	Minimum Reset Pulse Width	All	5	5	5	5	ns
F _{PFDMAX} ⁽⁵⁾	Maximum Frequency at the Phase Frequency Detector	LX devices	500	500	400	300	MHz
		LXT devices	500	500	400	N/A	MHz
F _{PFDMIN}	Minimum Frequency at the Phase Frequency Detector	LX devices	19	19	19	19	MHz
		LXT devices	19	19	19	N/A	MHz
T _{FBDELAY}	Maximum Delay in the Feedback Path	All	3 ns Max or one CLKIN cycle				

Notes:

1. LXT devices are not available with a -1L speed grade.
2. Values for this parameter are available in the Clocking Wizard.
3. The PLL does not filter typical spread spectrum input clocks because they are usually far below the bandwidth filter frequencies.
4. Includes global clock buffer.
5. Calculated as $F_{VCO}/128$ assuming output duty cycle is 50%.
6. When using CLK_FEEDBACK = CLKOUT0 with BUFIO2 feedback, the feedback frequency will be higher than the phase frequency detector frequency. $F_{PFDMAX} = F_{CLKFB} / CLKFBOUT_MULT$

Table 68: Global Clock Input to Output Delay With DCM and PLL in System-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, <i>with</i> DCM in System-Synchronous Mode and PLL in DCM2PLL Mode.							
T _{ICKOFDCM_PLL}	Global Clock and OUTFF with DCM and PLL	XC6SLX4	4.78	N/A	6.32	7.09	ns
		XC6SLX9	4.78	5.24	6.32	7.09	ns
		XC6SLX16	4.70	5.12	5.94	6.63	ns
		XC6SLX25	4.70	5.09	5.92	7.30	ns
		XC6SLX25T	4.70	5.09	5.92	N/A	ns
		XC6SLX45	4.63	4.98	5.83	7.26	ns
		XC6SLX45T	4.63	4.98	5.83	N/A	ns
		XC6SLX75	4.68	5.04	5.88	6.90	ns
		XC6SLX75T	4.68	5.04	5.88	N/A	ns
		XC6SLX100	4.72	5.07	5.92	7.77	ns
		XC6SLX100T	4.76	5.07	5.92	N/A	ns
		XC6SLX150	4.44	4.73	5.31	6.96	ns
		XC6SLX150T	4.44	4.73	5.31	N/A	ns
		XA6SLX4	5.07	N/A	6.18	N/A	ns
		XA6SLX9	5.07	N/A	6.18	N/A	ns
		XA6SLX16	5.22	N/A	5.77	N/A	ns
		XA6SLX25	5.01	N/A	5.80	N/A	ns
		XA6SLX25T	5.01	N/A	5.90	N/A	ns
		XA6SLX45	4.93	N/A	5.67	N/A	ns
		XA6SLX45T	4.93	N/A	5.67	N/A	ns
		XA6SLX75	4.94	N/A	5.70	N/A	ns
		XA6SLX75T	4.94	N/A	5.70	N/A	ns
		XA6SLX100	N/A	N/A	5.77	N/A	ns
		XQ6SLX75	N/A	N/A	5.70	6.90	ns
		XQ6SLX75T	4.94	N/A	5.70	N/A	ns
		XQ6SLX150	N/A	N/A	5.31	6.96	ns
		XQ6SLX150T	5.02	N/A	5.31	N/A	ns

Notes:

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. DCM and PLL output jitter are already included in the timing calculation.

Table 77: Global Clock Setup and Hold With DCM and PLL in Source-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
Example Data Input Set-Up and Hold Times Relative to a Forwarded Clock Input Pin, ⁽¹⁾ Using DCM, PLL, and Global Clock Buffer for the LVCMOS25 standard.							
T _{PSDCMPLL_0} / T _{PHDCMPLL_0}	No Delay Global Clock and IFF ⁽²⁾ with DCM in Source-Synchronous Mode and PLL in DCM2PLL Mode.	XC6SLX4	0.43/1.07	N/A	0.43/1.43	1.10/1.67	ns
		XC6SLX9	0.43/1.03	0.45/1.14	0.45/1.43	1.10/1.67	ns
		XC6SLX16	0.74/0.93	0.74/1.12	0.74/1.21	0.77/1.35	ns
		XC6SLX25	0.67/1.02	0.76/1.11	0.84/1.18	1.23/1.46	ns
		XC6SLX25T	0.67/1.02	0.76/1.11	0.84/1.18	N/A	ns
		XC6SLX45	0.65/0.99	0.65/1.04	0.71/1.12	1.18/1.58	ns
		XC6SLX45T	0.65/1.00	0.65/1.04	0.71/1.12	N/A	ns
		XC6SLX75	0.86/1.01	0.88/1.06	0.94/1.14	1.29/1.67	ns
		XC6SLX75T	0.86/1.01	0.88/1.06	0.94/1.14	N/A	ns
		XC6SLX100	0.50/1.10	0.56/1.10	0.61/1.17	0.84/2.24	ns
		XC6SLX100T	0.50/1.10	0.56/1.10	0.61/1.17	N/A	ns
		XC6SLX150	0.45/1.28	0.47/1.28	0.52/1.28	1.27/1.56	ns
		XC6SLX150T	0.45/1.28	0.47/1.28	0.52/1.28	N/A	ns
		XA6SLX4	0.74/1.00	N/A	0.74/1.43	N/A	ns
		XA6SLX9	0.74/1.00	N/A	0.74/1.43	N/A	ns
		XA6SLX16	1.81/1.15	N/A	1.81/1.03	N/A	ns
		XA6SLX25	0.89/1.01	N/A	0.96/1.05	N/A	ns
		XA6SLX25T	0.89/1.01	N/A	1.04/1.15	N/A	ns
		XA6SLX45	0.69/0.95	N/A	0.83/0.96	N/A	ns
		XA6SLX45T	0.69/0.95	N/A	0.83/0.96	N/A	ns
		XA6SLX75	0.88/0.94	N/A	1.06/0.96	N/A	ns
		XA6SLX75T	0.88/0.94	N/A	1.06/0.96	N/A	ns
		XA6SLX100	N/A	N/A	1.55/1.33	N/A	ns
		XQ6SLX75	N/A	N/A	1.06/0.96	1.29/1.67	ns
		XQ6SLX75T	0.88/0.94	N/A	1.06/0.96	N/A	ns
		XQ6SLX150	N/A	N/A	0.64/1.30	1.27/1.56	ns
		XQ6SLX150T	0.58/1.30	N/A	0.64/1.30	N/A	ns

Notes:

- Setup and Hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the Global Clock input signal using the slowest process, highest temperature, and lowest voltage. Hold time is measured relative to the Global Clock input signal using the fastest process, lowest temperature, and highest voltage. The timing values were measured using the fine-phase adjustment feature of the DCM. These measurements include CMT jitter; DCM CLK0 driving PLL, PLL CLKOUT0 driving BUFG. Package skew is not included in these measurements.
- IFF = Input Flip-Flop

Table 78: Duty Cycle Distortion and Clock-Tree Skew (Cont'd)

Symbol	Description	Device ⁽¹⁾	Speed Grade				Units
			-3	-3N	-2	-1L	
T _{BUFIOSKEW}	I/O clock tree skew across one clock region	LX4	0.06	N/A	0.06	0.07	ns
		LX9	0.06	0.06	0.06	0.07	ns
		LX16	0.06	0.06	0.06	0.07	ns
		LX25	0.06	0.06	0.06	0.07	ns
		LX25T	0.06	0.06	0.06	N/A	ns
		LX45	0.06	0.06	0.06	0.07	ns
		LX45T	0.06	0.06	0.06	N/A	ns
		LX75	0.06	0.06	0.06	0.07	ns
		LX75T	0.06	0.06	0.06	N/A	ns
		LX100	0.06	0.06	0.06	0.07	ns
		LX100T	0.06	0.06	0.06	N/A	ns
		LX150	0.06	0.06	0.06	0.07	ns
		LX150T	0.06	0.06	0.06	N/A	ns

Notes:

1. LXT devices are not available with a -1L speed grade. The LX4 is not available in -3N speed grade.
2. These parameters represent the worst-case duty cycle distortion observable at the pins of the device using LVDS output buffers. For cases where other I/O standards are used, IBIS can be used to calculate any additional duty cycle distortion that might be caused by asymmetrical rise/fall times.
3. The T_{CKSKEW} value represents the worst-case clock-tree skew observable between sequential I/O elements. Significantly less clock-tree skew exists for I/O registers that are close to each other and fed by the same or adjacent clock-tree branches. Use the Xilinx FPGA Editor and Timing Analyzer tools to evaluate clock skew specific to your application.
4. The T_{CKSKEW} is 0.43 ns for the XA6SLX100 device using a -2 speed grade and 0.22 ns for the XC6SLX100 devices using the -2 speed grade.

Table 79: Package Skew

Symbol	Description	Device	Package ⁽²⁾	Value	Units
T _{PKGSKEW}	Package Skew ⁽¹⁾	LX4	TQG144	N/A	ps
			CPG196	23	ps
			CSG225	58	ps
		LX9	TQG144	N/A	ps
			CPG196	23	ps
			CSG225	58	ps
			FT(G)256	88	ps
			CSG324	64	ps
		LX16	CPG196	19	ps
			CSG225	70	ps
			FT(G)256	71	ps
			CSG324	54	ps
		LX25	FT(G)256	90	ps
			CSG324	61	ps
			FG(G)484	84	ps
		LX25T	CSG324	48	ps
			FG(G)484	112	ps

Table 79: Package Skew (Cont'd)

Symbol	Description	Device	Package ⁽²⁾	Value	Units
T _{PKGSKEW}	Package Skew ⁽¹⁾	LX45	CSG324	70	ps
			CS(G)484	99	ps
			FG(G)484	109	ps
			FG(G)676	138	ps
		LX45T	CSG324	75	ps
			CS(G)484	100	ps
			FG(G)484	95	ps
		LX75	CS(G)484	101	ps
			FG(G)484	107	ps
			FG(G)676	161	ps
		LX75T	CS(G)484	107	ps
			FG(G)484	110	ps
			FG(G)676	134	ps
		LX100	CS(G)484	95	ps
			FG(G)484	155	ps
			FG(G)676	144	ps
		LX100T	CS(G)484	88	ps
			FG(G)484	111	ps
			FG(G)676	147	ps
			FG(G)900	134	ps
		LX150	CS(G)484	84	ps
			FG(G)484	103	ps
			FG(G)676	115	ps
			FG(G)900	121	ps
		LX150T	CS(G)484	83	ps
			FG(G)484	88	ps
			FG(G)676	141	ps
			FG(G)900	120	ps

Notes:

- These values represent the worst-case skew between any two SelectIO resources in the package: shortest delay to longest delay from Pad to Ball.
- Some of the devices are available in both Pb and Pb-free (additional G) packages as standard ordering options. See [DS160: Spartan-6 Family Overview](#) for more information.

Table 80: Sample Window

Symbol	Description	Device ⁽¹⁾	Speed Grade				Units
			-3	-3N	-2	-1L	
T _{SAMP}	Sampling Error at Receiver Pins ⁽²⁾	All	510	510	530	740	ps
T _{SAMP_BUFIO2}	Sampling Error at Receiver Pins using BUFIO2 ⁽³⁾	All	430	430	450	590	ps

Notes:

- LXT devices are not available with a -1L speed grade.
- This parameter indicates the total sampling error of Spartan-6 FPGA DDR input registers, measured across voltage, temperature, and process. The characterization methodology uses the DCM to capture the DDR input registers' edges of operation. These measurements include:
 - CLK0 DCM jitter
 - DCM accuracy (phase offset)
 - DCM phase shift resolution
These measurements do not include package or clock tree skew.
- This parameter indicates the total sampling error of Spartan-6 FPGA DDR input registers, measured across voltage, temperature, and process. The characterization methodology uses the BUFIO2 clock network and IODELAY2 to capture the DDR input registers' edges of operation. These measurements do not include package or clock tree skew.

Table 81: Source-Synchronous Pin-to-Pin Setup/Hold and Clock-to-Out Using BUFIO2

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
Data Input Setup and Hold Times Relative to a Forwarded Clock Input Pin Using BUFIO2							
T _{PSCS} /T _{PHCS}	IFF setup/hold using BUFIO2 clock	XC6SLX4	0.57/0.94	N/A	0.95/1.12	0.27/1.56	ns
		XC6SLX9	0.40/0.95	0.50/0.96	0.60/1.12	0.27/1.56	ns
		XC6SLX16	0.48/0.74	0.55/0.75	0.69/0.83	1.27/1.31	ns
		XC6SLX25	0.28/1.02	0.28/1.12	0.28/1.24	0.15/1.78	ns
		XC6SLX25T	0.28/1.02	0.28/1.12	0.28/1.24	N/A	ns
		XC6SLX45	0.42/1.19	0.44/1.29	0.50/1.40	0.12/1.83	ns
		XC6SLX45T	0.42/1.19	0.44/1.29	0.50/1.40	N/A	ns
		XC6SLX75	0.38/1.48	0.38/1.63	0.38/1.84	0.05/2.78	ns
		XC6SLX75T	0.38/1.48	0.38/1.63	0.38/1.84	N/A	ns
		XC6SLX100	0.06/1.48	0.06/1.63	0.06/1.87	−0.03/2.72	ns
		XC6SLX100T	0.06/1.48	0.06/1.63	0.06/1.87	N/A	ns
		XC6SLX150	0.04/1.73	0.04/1.75	0.04/1.98	−0.08/3.07	ns
		XC6SLX150T	0.04/1.73	0.04/1.75	0.04/1.98	N/A	ns
		XA6SLX4	0.64/0.96	N/A	0.97/1.12	N/A	ns
		XA6SLX9	0.44/0.99	N/A	0.62/1.16	N/A	ns
		XA6SLX16	0.50/0.78	N/A	0.69/0.83	N/A	ns
		XA6SLX25	0.28/1.04	N/A	0.28/1.25	N/A	ns
		XA6SLX25T	0.28/1.04	N/A	0.28/1.25	N/A	ns
		XA6SLX45	0.43/1.21	N/A	0.50/1.40	N/A	ns
		XA6SLX45T	0.43/1.21	N/A	0.50/1.40	N/A	ns
		XA6SLX75	0.38/1.49	N/A	0.38/1.84	N/A	ns
		XA6SLX75T	0.38/1.49	N/A	0.38/1.84	N/A	ns
		XA6SLX100	N/A	N/A	1.01/1.63	N/A	ns
		XQ6SLX75	N/A	N/A	0.38/1.84	0.05/2.78	ns
		XQ6SLX75T	0.38/1.49	N/A	0.38/1.84	N/A	ns
		XQ6SLX150	N/A	N/A	0.04/1.98	−0.08/3.07	ns
		XQ6SLX150T	0.04/1.75	N/A	0.04/1.98	N/A	ns

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